



Dell™								
	OptiPlex [™] 745	NAINUTOVA/ED	DECKTOR	SMALL FORM	ULTRA SMALL			
Tech S		MINITOWER	DESKTOP	FACTOR	FORM FACTOR			
				TAGTOR	TOTALITACION			
ARD DRIVE								
	Supported Types	Serial ATA or Serial ATA 3.0						
	Available Drives	7200RPM SATA 3.0Gb/s: 80GB, 1600	GB, 250GB ⁴ 7200RPM					
			10K RPM SATA 1.5Gb/s: 80GB					
	SMART Technology	SMART III						
	Burst Transfer Rate	300 Mbit/s	0	TOO : 111 - 11 - 11 - 12 - 12 - 12				
	Partition Support	MS Windows XP Professional SP2:	• •	132 will be the default configuration				
VOTEM DO	ARD CONNECTORS	MS Windows XP Home SP2: Suppo	T TOUR PATTO a		1			
ITSTEIN BUA	Serial ATA	Four 7 nin connectors	Tura 7 nin connectors	Tivo 7 nin connectors	One 7 nin connector			
		Four 7-pin connectors Two 7-pin connectors One 7-pin connector 34-pin connector						
	Floppy drive Serial		ovial nave and I not available on HC	TT)				
	Fan	12-pin connector, optional second s	serial port card (not available on 05	rr)				
	PCI 2.3	5-pin connector						
	Front panel	120-pin connector 40-pin connector						
TANDARD I	· · · · · · · · · · · · · · · · · · ·	* Front ports may be disabled			T			
TANDARD I	Display Port	1 VGA Out (15-hole)			DVI-I Out			
	USB 2.0	Two front and six rear			Two front and five rear			
	Serial Port	One, rear.			One rear			
	Optional Adapters	One, rear. 12-pin proprietary conne	ctor for PS/2 adapter or a second se	orial nort	Not available on USFF			
	Internal USB	10-pin connector for optional media	<u> </u>	in porc	Not available on oor i			
	Parallel Port	One, rear (25-hole, bi-directional)	i buy ucvice					
	Ethernet Network	One, rear (RJ45)						
	Stereo line-in	One minijack, rear						
	Speakers, line-out	One minijack, rear						
	Microphone-in	One minijack, front						
	Headphone	One minijack, front						
OMPUTER I	NFORMATION	Cite illinguoty il cite						
	System Clock	Utilizes the CK-505 clock synthesize	er chip, which incorporates Intel spe	ecifications for clock generation				
	Data bus width	64 bits	omp, which most portates missi ope	one did not be a general and n				
	Address bus width	36 bits						
	DMA channels	Eight						
	Interrupt levels	24						
	Interrupt levels							
XPANSION	BUS INFORMATION							
XPANSION		PCI: 33 MHz						
XPANSION	BUS INFORMATION PCI 2.3							
XPANSION	BUS INFORMATION	PCI: 33 MHz PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps						
XPANSION	PCI 2.3 PCI Express 1.0a	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps						
XPANSION	BUS INFORMATION PCI 2.3	PCI Express x1: 5 Gbps						
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps	Not available	Not available	Not available			
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps	Not available	Not available	Not available			
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height	Not available	Not available	Not available			
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins	Not available	Not available	Not available			
PCI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane	Not available	Not available	Not available			
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total	Not available	Not available	Not available			
	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V	Not available Two Low-Profile on board	Not available One Low-Profile	Not available Not available			
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1)						
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1)	Two Low-Profile on board					
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1)	Two Low-Profile on board Riser options: *					
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1)	Two Low-Profile on board Riser options: * - Dual PCI Riser					
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height	Two Low-Profile on board Riser options: * - Dual PCI Riser					
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser	One Low-Profile				
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size Data Bus Voltage Power Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height 120 pins 32Bit/33MHz	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser	One Low-Profile				
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size Data Bus Voltage Power Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height 120 pins 32Bit/33MHz 3.3 Volt External Operation (some pins)	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser	One Low-Profile	Not available			
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size Data Bus Voltage Power Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height 120 pins 32Bit/33MHz 3.3 Volt External Operation (some pins)	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser	One Low-Profile	Not available			
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CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size Data Bus Voltage Available slots	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height 120 pins 32Bit/33MHz 3.3 Volt External Operation (some pin One Full-Height	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser ins 5 Volt Tolerant); 1.8V internal reg One Low-Profile Riser option: * Combo x16/PCI Riser	One Low-Profile	Not available			
CI-E x1	BUS INFORMATION PCI 2.3 PCI Express 1.0a SATA 1.0a and 2.0 USB 2.0 Available slots Connector Size Data Bus Voltage Power Available slots Connector size Data Bus Voltage Available slots Connector Size Connector Size	PCI Express x1: 5 Gbps PCI Express x16: 80 Gbps SATA: 1.5 and 3.0 Gbps USB: 480 Mbps One full height 36 pins One bi-directional differential lane pair (2.5Gbs per lane) 5Gbs total 3.3V 10 W (x1) Two Full-Height 120 pins 32Bit/33MHz 3.3 Volt External Operation (some pi One Full-Height	Two Low-Profile on board Riser options: * - Dual PCI Riser - Combo x16/PCI Riser ins 5 Volt Tolerant); 1.8V internal reg One Low-Profile Riser option: * Combo x16/PCI Riser	One Low-Profile	Not available			

^{*} One low-profile slot remains available on board when riser installed

Dell™ OptiPlex™ 745 Tech Specs	MINITOWER	DESKTOP	SMALL FORM FACTOR	ULTRA SMALL FORM FACTOR		
тест ореез			FACTUR	TOTINTACTOR		
grated Intel Graphics Media Accelerator	965					
Graphics Core	Intel® Graphics Media Accelerator 300)0				
Memory						
Maximum Resolution Supports 640 x 480 up to 1920 x 1200 (refresh rates and additional resolutions are dependant on display)						
RAMDAC	400MHz, 24-bit					
Display Interface	VGA DB-15 (analog)			DVI-I native. Optional Y-dongle		
Diopila, illiano	To, (22 to (analog)			Cable provides VGA output.		
Dual Monitor Support	Yes, in conjunction with discrete graphi	ios card		Yes, with dual dongle		
	Yes	ics card		res, with dual dollgle		
Display Rotation Support						
Core Processor Speed	667MHz					
3D Setup & Render Engine						
Controller clock speed (MHz)						
	sDV0 Frequency: 270MHz					
'I (Digital) Adapter Card						
Memory	Uses integrated graphics. No memory d	Jedicated		Not available		
Card Type	Intel digital video output via PCI Express	s		Integrated graphics only		
Maximum Resolution	1920 x 1200 @ 60 Hz & 16.7 million colors			DVI-I output		
Display Interface	DVI-D					
Dual Monitor Support	Extended Desktop using two display ada	anters				
Duai Monitor Support	Clone and Twin display capabilities	uptoro				
0-4:				_		
Options	Full height or low profile					
Details	Uses Integrated Graphics—Intel digital	video output via PCI Express				
8MB ATI Radeon® X1300						
Memory	128MB DDR SDRAM			Not available		
Card Type	PCI Express X16			Integrated graphics only		
Maximum Resolution	1920 x 1200 @ 75 Hz & 16.7 million colors	s		DVI-I output		
RAMDAC	Dual 400MHz					
Display Interface	Single DVI-I (VGA via included DVI to VI	GA Adapter) and S-Video TV-Out				
Dual Monitor Support	No			_		
Display Rotation Support	Yes			_		
				_		
Options	Full height or low profile					
ONAD ATLICA I A TRAVESCO DA						
6MB ATI Radeon™ X1300 Pro						
Memory	256MB DDR SDRAM			Not available		
Card Type	PCI Express X16			Integrated graphics only DVI-I output		
Maximum Resolution	1920 x 1200 @ 75Hz & 16.7 million colors	3				
RAMDAC	Dual 400MHz					
	Dual VGA (DB-15) or DVI via optional DN	MS-59 cables				
Display Interface	Dual Monitor Support Yes					
Display Interface Dual Monitor Support						
Dual Monitor Support						
Dual Monitor Support Display Rotation Support	Full height or law profil-					
Dual Monitor Support	Full height or low profile					
Dual Monitor Support Display Rotation Support Options	Full height or low profile					
Dual Monitor Support Display Rotation Support Options						
Dual Monitor Support Display Rotation Support Options	Full height or low profile ADI 1983 High Definition Audio					

DC Power Supply - Wettage 309/W 280W 275/W 220W (External power brick)	DC Power Supply - Wattage 305W 280W 275W 220W (External power brick) Power Efficiency 75% 76% 76% 76% 36% 80% 75% 80% 75% 75% 75% 75% 75% 75% 80% 75	Dell™ OptiPlex™ 745 Tech Specs	MINITOWER	DESKTOP	SMALL FORM FACTOR	ULTRA SMALL FORM FACTOR			
Power Efficiency 76% 76% 76% 76% 76% 80%	Power Efficiency	OWER							
Heat Dissipation * 1041 BTU/hr 956 BTU/hr 339 BTU/hr 751 BTU/hr	Heart Dissipation * 1041 BTUhr 968 BTUhr 988 BTUhr 971 BTUhr	DC Power Supply - Wattage	305W	280W	275W	220W (External power brick)			
NOTE: Heat dissipation is calculated based upon the power supply rating. Does not include peripherals. **Voltage - Manuel selection Manuel selection power supplies: 90 to 135 V at 50/60 Hz; 180 to 265 V at 50/60 Hz	**NOTE: Heart dissipation is calculated based upon the power supply rating. Does not include peripherals. Voltage - Manual selection Beckup battery 3-V CR2032 coin cell, Lithium ion **NOWER MANAGEMENT ACP! Wake-Up Event	Power Efficiency	76%	76%	76%	80%			
Voltage - Manual selection Manual selection power supplies: 90 to 135 V at 50/60 Hz; 180 to 265 V at 50/60 Hz External - Auto sensing	Voltage - Manual selection Manual selection power supplies: 90 to 135 V at 50/60 Hz; 180 to 265 V at 50/60 Hz	Heat Dissipation *	1041 BTU/hr	956 BTU/hr	939 BTU/hr	751 BTU/hr			
Backup bettery 3-V CR2032 coin cell, Lithium ion	Beckup bettery 3-V CR2032 coin cell, Lithium ion								
ACPL Wake-Up Event System Wakes From Suspend or soft-off	ACPL Wake-Up Event Power Button Suspend or soft-off		Manual selection power supplies:	: 90 to 135 V at 50/60 Hz; 180 to 265 V a	at 50/60 Hz	External - Auto sensing			
ACPI Wake-Up Event Power Button Suspend or soft-off	ACP! Wake-Up Event Power Button Suspend or soft-off								
ACPI Wake-Up Event Power Button Suspend or soft-off	ACP! Wake-Up Event Power Button Suspend or soft-off								
Power Button Suspend or soft-off	Power Button Suspend or soft-off								
RTC Alarm	### Action Suspend or soft-off	·							
Wake On LAN Suspend or soft-off	Wake On LAN Suspend or soft-off								
PME Suspend or soft-off	PME Suspend or soft-off								
Serial Port Ring	Serial Port Ring Suspend or soft-off USB Suspend only		<u> </u>						
USB	USB		· ·						
Residence Suspend only Suspend only	Note Suspend only		· ·						
Mouse Suspend only	Mouse Suspend only		<u> </u>						
Hassis discrete Height	CHASSIS DIMENSIONS								
Height	Height	Mouse	Suspend only						
Height	Height	CHASSIS DIMENSIONS							
Width 18.5 cm (7.3 inches) 39.9 cm (15.7 inches) 31.37 cm (12.35 inches) 8.9 cm (3.5 inches)	Width 18.5 cm (7.3 inches) 39.9 cm (15.7 inches) 31.37 cm (12.35 inches) 8.9 cm (3.5 inches)		41.4 cm (16.2 inches)	11 4 cm (4 5 inches)	9.26 cm /2.65 inches)	26.4 cm (10.27 inches)			
Depth	Depth		, ,						
Weight 12.34 kg (27.2 lb) 10.4 kg (23 lb) 7.4 kg (16.4 lb) 4.5 kg (10 lb)	Weight 12.34 kg (27.2 lb) 10.4 kg (23 lb) 7.4 kg (16.4 lb) 4.5 kg (10 lb)		·	<u> </u>	·				
Volume 33 Liters 15.7 Liters 9.97 Liters 6 Liters	Volume								
HYSICAL ATTRIBUTES Temperature Operating 10° to 35°C (50° to 95°F) 10° to 30°C (50° to 86°F) Storage -40° to 65°C (-40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	PHYSICAL ATTRIBUTES Temperature								
Temperature Operating 10° to 35°C (50° to 95°F) 10° to 30°C (50° to 86°F) Storage -40° to 65°C (-40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Temperature Operating	Volumo	JO LICIS	10.7 Liters	J.J/ Liters	0 Energ			
Temperature Operating 10° to 35°C (50° to 95°F) 10° to 30°C (50° to 86°F) Storage -40° to 65°C (-40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Temperature	PHYSICAL ATTRIBUTES							
Operating 10° to 35°C (50° to 95°F) 10° to 30°C (50° to 86°F) Storage -40° to 65°C (-40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Operating 10° to 35°C (50° to 95°F) 10° to 30°C (50° to 86°F) Storage -40° to 65°C (-40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min Maximum shock 0perating Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)								
Storage	Storage —40° to 65°C (—40° to 149°F) Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min Maximum shock Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating —15.2 to 3048 m (—50 to 10,000 ft)		10° to 35°C (50° to 95°F)			10° to 30°C (50° to 86°F)			
Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Relative humidity 20% to 80% (non-condensing) Maximum vibration Operating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min Maximum shock Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)								
Maximum vibration 0 perating 0.25 G at 3 to 200 Hz at 0.5 octave/min Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Maximum vibrationOperating0.25 G at 3 to 200 Hz at 0.5 octave/minStorage0.5 G at 3 to 200 Hz at 1 octave/minMaximum shockOperatingBottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec)Storage27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec)AltitudeOperating-15.2 to 3048 m (-50 to 10,000 ft)		Relative humidity 20% to 80% (non-condensing)						
Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Storage 0.5 G at 3 to 200 Hz at 1 octave/min Maximum shock Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)								
Storage 0.5 G at 3 to 200 Hz at 1 octave/min	Storage 0.5 G at 3 to 200 Hz at 1 octave/min Maximum shock Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)		0.25 G at 3 to 200 Hz at 0.5 octave/min						
	Maximum shock Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)								
	Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec) Altitude Operating -15.2 to 3048 m (-50 to 10,000 ft)								
Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec)	Altitude	Operating	Bottom half-sine pulse with a cha	nge in velocity of 50.8 cm/sec (20 inc	hes/sec)				
Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec)	Altitude	Storage	27-G faired square wave with a ve	elocity change of 508 cm/sec (200 inc	ches/sec)				
		-							
Autuue	Storage -15.2 to 10,668 m (-50 to 35,000 ft)	Operating	-15.2 to 3048 m (-50 to 10,000 ft)						
		Storage	-15.2 to 10,668 m (-50 to 35,000 ft))					
Operating Bottom half-sine pulse with a change in velocity of 50.8 cm/sec (20 inches/sec) Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec)		Operating Storage Maximum shock Operating Storage Altitude	0.5 G at 3 to 200 Hz at 1 octave/mi Bottom half-sine pulse with a chal 27-G faired square wave with a ve	in nge in velocity of 50.8 cm/sec (20 inc					
Storage 27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec)	Operating -15.2 to 3048 m (-50 to 10,000 ft)	Storage	27-G faired square wave with a ve	elocity change of 508 cm/sec (200 inc	ches/sec)				
			-15 2 to 3048 m (-50 to 10 000 ft)						
	1 TOLE OF TOPOGO IN T. SO TO OUTON TO								
Operating -15.2 to 3048 m (-50 to 10,000 ft)									

Tech Specs	ex [™] 745	MINITOWER	DESKTOP	SMALL FORM FACTOR	ULTRA SMALL FORM FACTOR	
NCLOSURE & VENTIL	ATION REQUIREMENTS					
Enclosure	ventilation	If your enclosure has doors, they nee least 30% airflow through the enclos			10-3 mm	
Enclosure	Minimum Clearance	Leave a 10.2 cm (4 in.) minimum clearance on all vented sides of the computer to permit the airflow required for proper ventilation.				
Recomme	ended Enclosure	Do not install your computer in an en This restricts the airflow and impacts possibly causing it to overheat.				
Open Des	k Minimum Clearance	If your computer is installed in a corr leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requi	from the back of the computer			
Open Des	k Minimum Clearance	leave at least 5.1 cm (2 in.) clearance	from the back of the computer			
	k Minimum Clearance	leave at least 5.1 cm (2 in.) clearance	from the back of the computer red for proper ventilation.	JEMKO, NFPA99, SABS, SASO, TCO,		
TANDARDS	(All Chassis)	TCO99, Blue Angel, Green PC, Energy	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N			
CANDARDS OS Factory Defaults OS address	(All Chassis) F0000h	TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N	Low power mode	Off	
OS Factory Defaults OS address OS chip (NVRAM)	(All Chassis) F0000h 8Mb	TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On	Low power mode Password	Off Disabled	
OS Factory Defaults OS address OS chip (NVRAM) stup Option	(All Chassis) F0000h	TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N	Low power mode	Off	
OS Factory Defaults OS address OS chip (NVRAM) tup Option trallel Port mode	(All Chassis) F0000h 8Mb Default Factory Value	leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requi TC099, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay Serial #1 Port Keyboard Num lock	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto	Low power mode Password POST hot keys SATA drives	Off Disabled Setup & Boot Menu	
OS Factory Defaults OS address OS chip (NVRAM) tup Option trallel Port mode trallel Port address	(All Chassis) F0000h 8Mb Default Factory Value PS/2	leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requirements of the wall to permit the airflow requirements of the wall to permit the wall the wall to permit the wall the	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report	Low power mode Password POST hot keys	Off Disabled Setup & Boot Menu On	
OS Factory Defaults OS address OS chip (NVRAM) otup Option irallel Port mode irallel Port address ake on LAN	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378	I leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requirements of the wall to permit the airflow requirements of the wall to permit the wall the wall to permit the wall the	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On	Low power mode Password POST hot keys SATA drives Floppy	Off Disabled Setup & Boot Menu On Internal	
OS Factory Defaults OS address OS chip (NVRAM) etup Option arallel Port mode arallel Port address ake on LAN	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off	TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay Serial #1 Port Keyboard Num lock Keyboard error report Onboard Video	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Auto	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID	Off Disabled Setup & Boot Menu On Internal Off	
IOS Factory Defaults IOS address IOS chip (NVRAM) etup Option arallel Port mode arallel Port address fake on LAN ST nboard Audio	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off Off	TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay Serial #1 Port Keyboard Num lock Keyboard error report Onboard Video HD Acoustic mode	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Bypass	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID ASF Settings	Off Disabled Setup & Boot Menu On Internal Off Off	
TANDARDS IOS Factory Defaults IOS address IOS chip (NVRAM) etup Option arallel Port mode arallel Port address /ake on LAN IST INDOARD Audio INDOARD MODEM	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off Off On	I leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requipers to the wall to permit the airflow requipers to the wall to permit the airflow requipers. TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay Serial #1 Port Keyboard Num lock Keyboard error report Onboard Video HD Acoustic mode Onboard Video buffer	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Bypass 8MB	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID ASF Settings HD Password	Off Disabled Setup & Boot Menu On Internal Off Off Disabled	
TANDARDS IOS Factory Defaults IOS address IOS chip (NVRAM) etup Option arallel Port mode arallel Port address Vake on LAN IST Inboard Audio Inboard Modem lex bay	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off Off On	I leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requirement of the wall to permit only the wall to permit only the wall to the w	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Bypass 8MB Add-in	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID ASF Settings HD Password Hyper-threading	Off Disabled Setup & Boot Menu On Internal Off Off Disabled On	
TANDARDS IOS Factory Defaults IOS address IOS chip (NVRAM) etup Option arallel Port mode arallel Port address Vake on LAN IST inboard Audio inboard Modem lex bay xecute Disable inboard NIC	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off Off On On On (no boot)	I leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow required to the wall to permit the wall the wa	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Bypass 8MB Add-in S3	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID ASF Settings HD Password Hyper-threading Auto Power on Auto Power time SERR	Off Disabled Setup & Boot Menu On Internal Off Off Disabled On Off	
Open Des STANDARDS SIOS Factory Defaults SIOS address SIOS chip (NVRAM) Setup Option Parallel Port mode Parallel Port address Vake on LAN SIST Onboard Audio Onboard Modem Siex bay Execute Disable Onboard NIC PS2 Mouse Onboard USB	(All Chassis) F0000h 8Mb Default Factory Value PS/2 378 Off Off On On On (no boot) On	leave at least 5.1 cm (2 in.) clearance to the wall to permit the airflow requipers to the wall to permit the airflow requipers. TCO99, Blue Angel, Green PC, Energy TUV, UL, VCCI, USB 2.0, WEEE USB front panel Module bay Serial #1 Port Keyboard Num lock Keyboard error report Onboard Video HD Acoustic mode Onboard Video buffer Primary Video Suspend mode Chassis intrusion	from the back of the computer red for proper ventilation. Star, BSMI, C-TICK, CE, FCC, IRAM, N On On Auto Report On Auto Bypass 8MB Add-in S3 On	Low power mode Password POST hot keys SATA drives Floppy Limit CPUID ASF Settings HD Password Hyper-threading Auto Power on Auto Power time	Off Disabled Setup & Boot Menu On Internal Off Off Disabled On Off Disabled On Off	

Dell™ OptiPlex™ 745 Tech Specs		MINITOWER	DESKTOP	SMALL FORM FACTOR	ULTRA SMALL FORM FACTOR			
DISPLAYS	CRT	17" E773s (16.0" viewable) Conventional CRT						
			17" E773MM (16.0" viewable) Multimedia CRT					
	Dell Flat Panel Analog	15" E157FP Flat Panel						
		17" E177FP Flat Panel						
	B. II.II. 61 TV	19" E197FP Flat Panel						
	Dell UltraSharp™	17" UltraSharp™ 1707FP						
	Digital Flat Panel	17" UltraSharp™ 1707FPV						
	Adjustable Stand, VGA/DVI	19" UltraSharp™ 1907FP 19" UltraSharp™ 1907FPV 20" UltraSharp™ 2007FP 20" Widescreen UltraSharp™ 2007FPW						
	B 11161 111. 01 711							
	Dell Widescreen UltraSharp™	'						
	Digital Flat Panel	24" Widescreen UltraSharp™ 2407FP\	N					
	Dell All-In-One UltraSharp™ Solution	None			UltraSharp™ 1706FP All-In-One			
PERIPHERALS								
	Keyboard	Dell USB Keyboard, No Hot Keys						
		Dell USB Enhanced Multimedia Keybo	pard					
		Smart Card Reader USB Keyboard						
		Bluetooth Keyboard						
	Mouse	Dell USB 2-Button Entry Mouse with Scroll, Black						
	Dell USB 2-Button Optical Premium Mouse with Scroll, Black							
		Bluetooth Mouse						
	Audio	Internal Dell Business Audio Speaker						
		Dell A225 Stereo Speakers						
		Dell A525 Speakers						
		Dell AS501 Sound Bar - UltraSharp Flat Panel Attachable Speakers						
		Dell AS501PA Sound Bar - Entry FP At	tachable Speakers					
	Optical Storage Drive	48X CD-ROM SATA		24X Slimline CD-ROM Drive				
		16X DVD-ROM SATA		8X Slimline DVD-ROM				
		48X32 CDRW/DVD Combo SATA 24X Slimline CDRW/DVD Combo						
		16X DVD+/-RW SATA		8X Slimline DVD+/-RW				
	Additional Storage	3.5" 1.44MB FDD		Slimline 1.44MB FDD				
		USB 2.0 Memory Key: 256MB, 512MB						
		Dell 13 in 1 USB Media Card Reader						
	Communications	Integrated Broadcom 10/10/10000Mb	LOM					
		Dell V.92 PCI Data/Fax Controllerless I	Modem					
		Broadcom NetXtreme 10/100/1000 PCI	e Gigabit Controller Card (Full Hei	ight or Low-profile)				
		Dell Wireless 1450 (802.11 a/b/g) WLA	Dell Wireless 1450 (802.11 a/b/g) WLAN USB 2.0 DT Adapter, 13 Channel					





- 1. The term Gigabit Ethernet does not connote an actual operating speed of 1 GB/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.
- 2. Up to 256MB of system memory may be allocated to support graphics, depending on system memory size and other factors.
- 3. The total amount of usable memory available will be less than 4 GB, depending on the actual system configuration
- For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating system and will be less.
 Discs burned with this drive may not be compatible with some existing drives and players; using DVD+R media provides maximum compatibility.
- 6. For a copy of Dell's guarantees or limited warranties, please write Dell USA L.P., Attn: Warranties, One Dell Way, Round Rock, TX 78682. For more information, visit www.dell.com/us/en/gen/service_service_plans.htm.
- 7. Service may be provided by third-party. Technician will be dispatched if necessary following phone based troubleshooting. Subject to parts availability, geographical restrictions and terms of service contract. Service timing dependent upon time of day call placed to Dell. U.S. only.

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